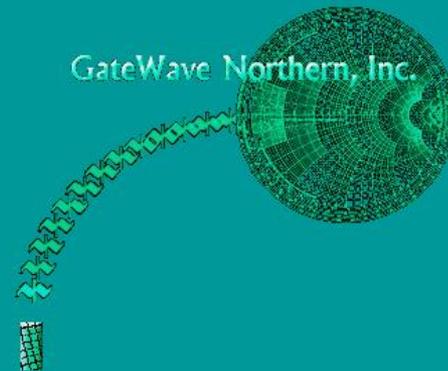


# GateWave Northern

## Socket/connector to PCB interface optimization



06/26/15

# Objective and approach

- Demonstrate need for proper selection of PCB parameters to achieve optimal socket or connector performance
- HFSS 3D field simulator with model of a PCB section plus socket / connector
- Unoptimized cases plus quick/fully optimized cases

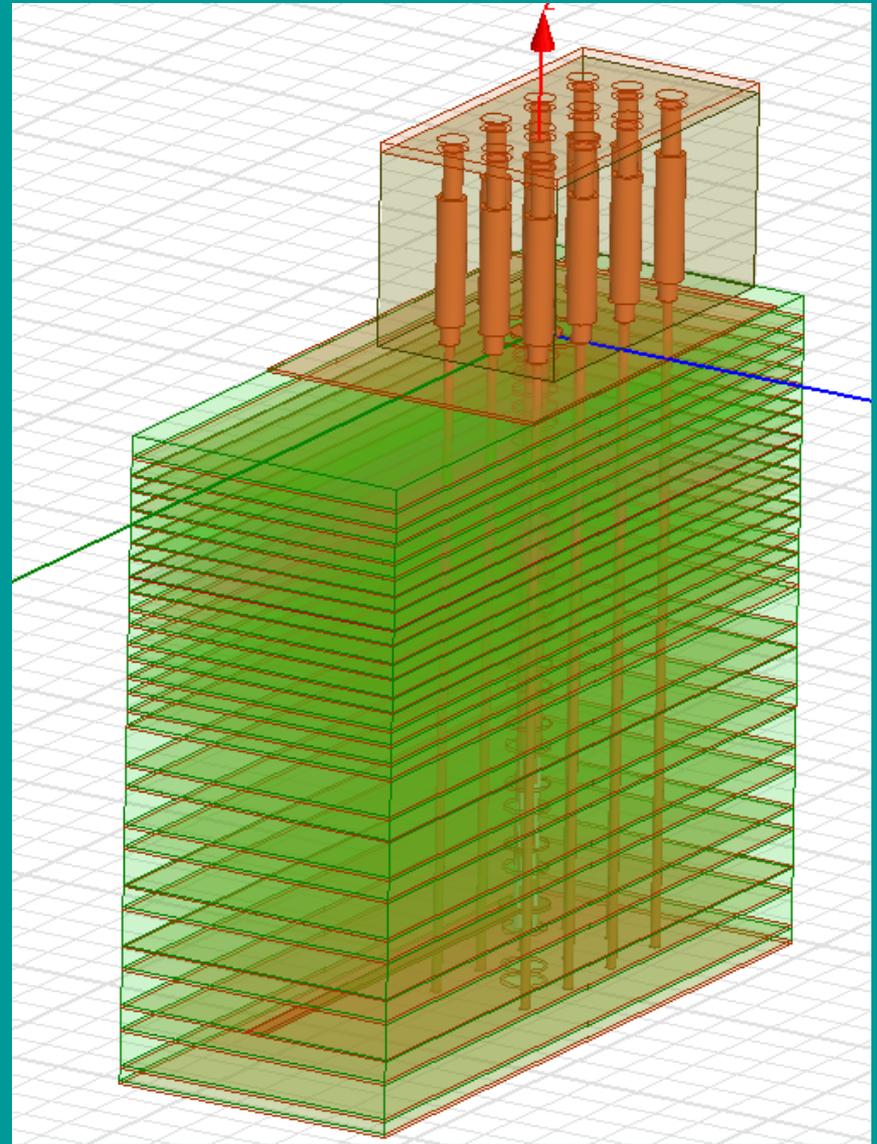
# Why via field optimizations

- Insertion loss ( $S_{21}$ ) minimization
- Return loss  $S_{11}$  optimization (perhaps even more important than  $S_{21}$ )
- Crosstalk forecast and budgeting
- Effective inductance determination
- Timing and jitter analysis and adjustment
- Waveform/eye diagram improvement

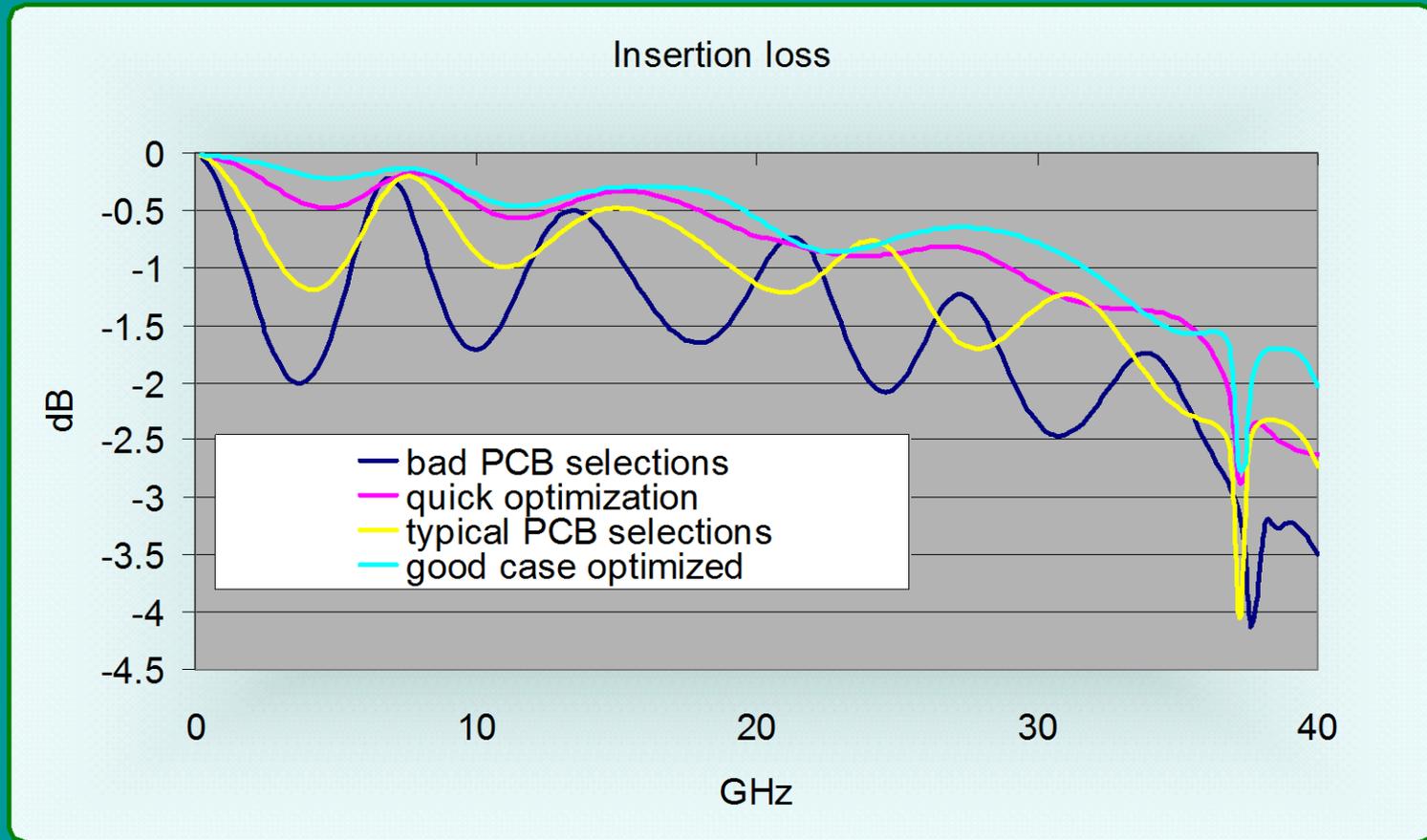
# Setup

Multi-layer PCB with a basic pogo pin socket example.

Feed via stripline near bottom layer.

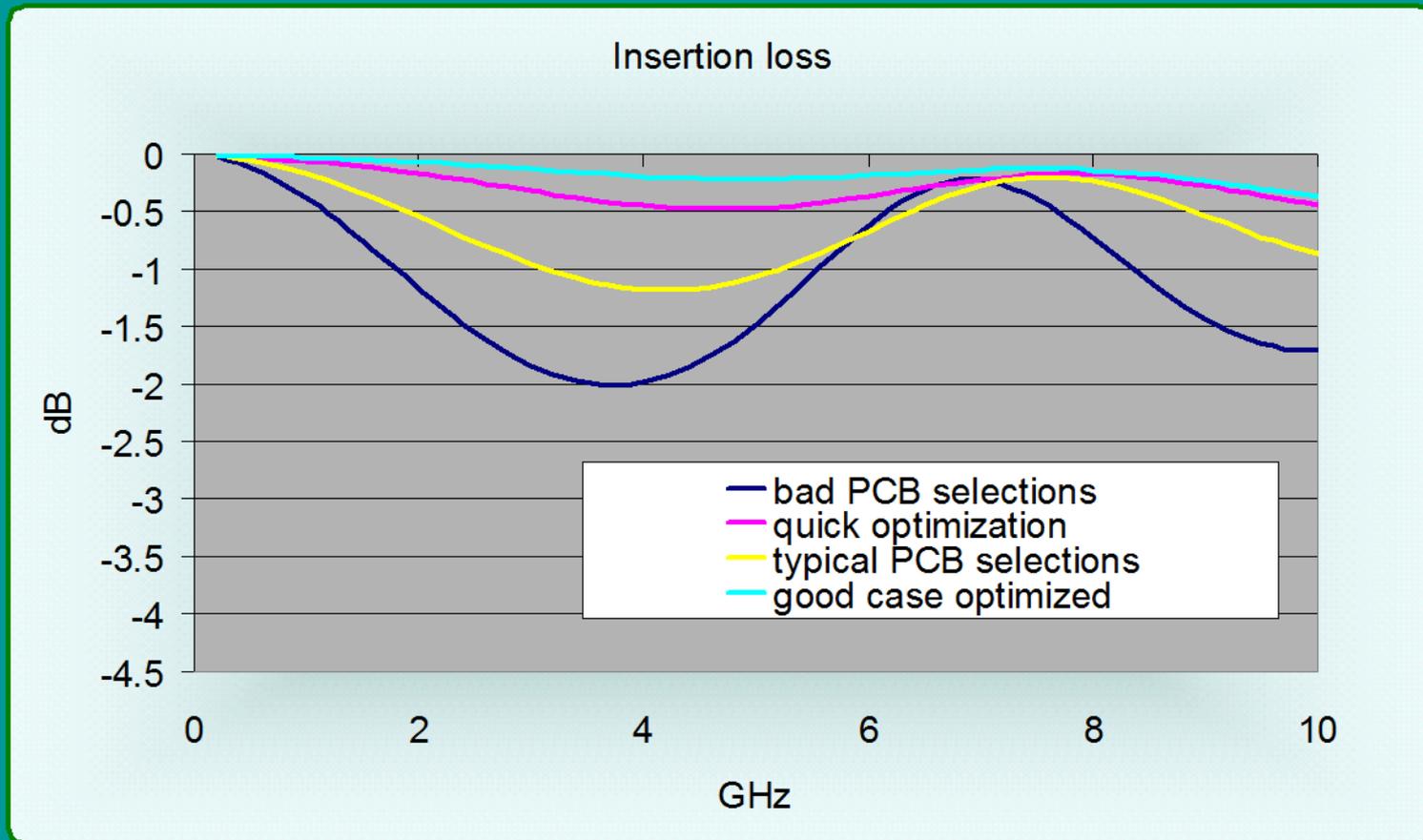


# Insertion loss S21



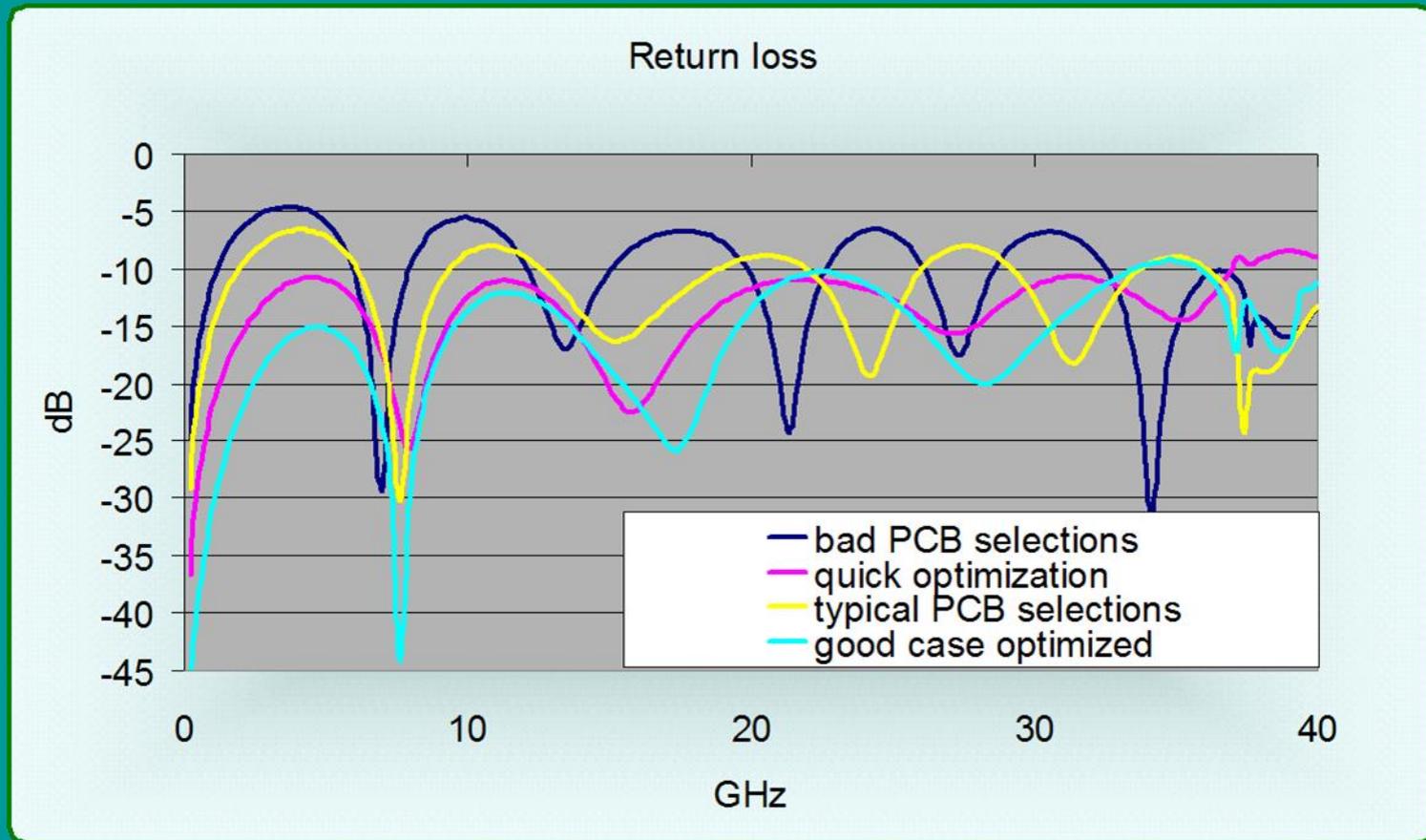
Insertion loss varies greatly depending on PCB parameter selections (pad and antipad sizes)

# Insertion loss S21



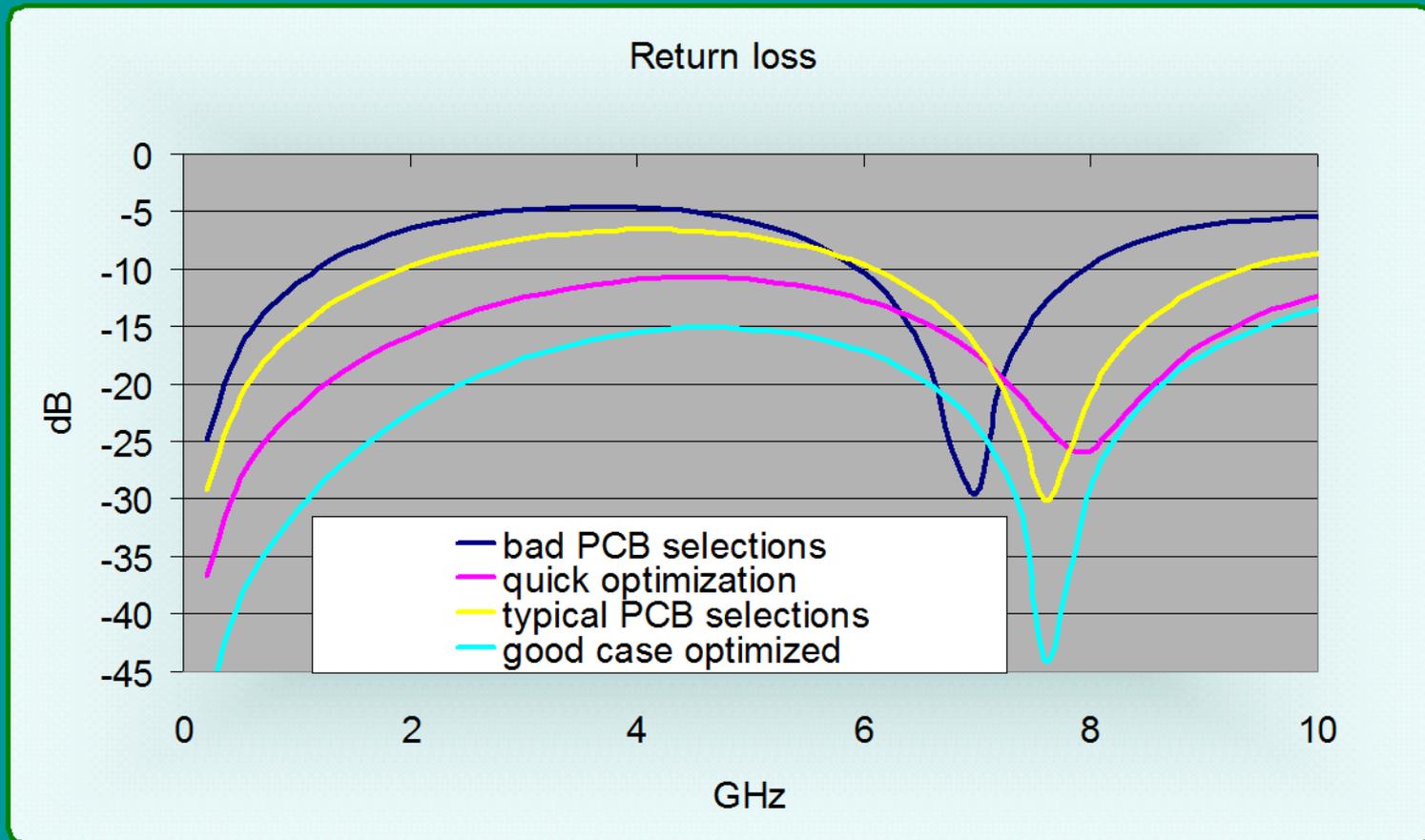
Substantial differences exist even at lower frequencies

# Return loss S11



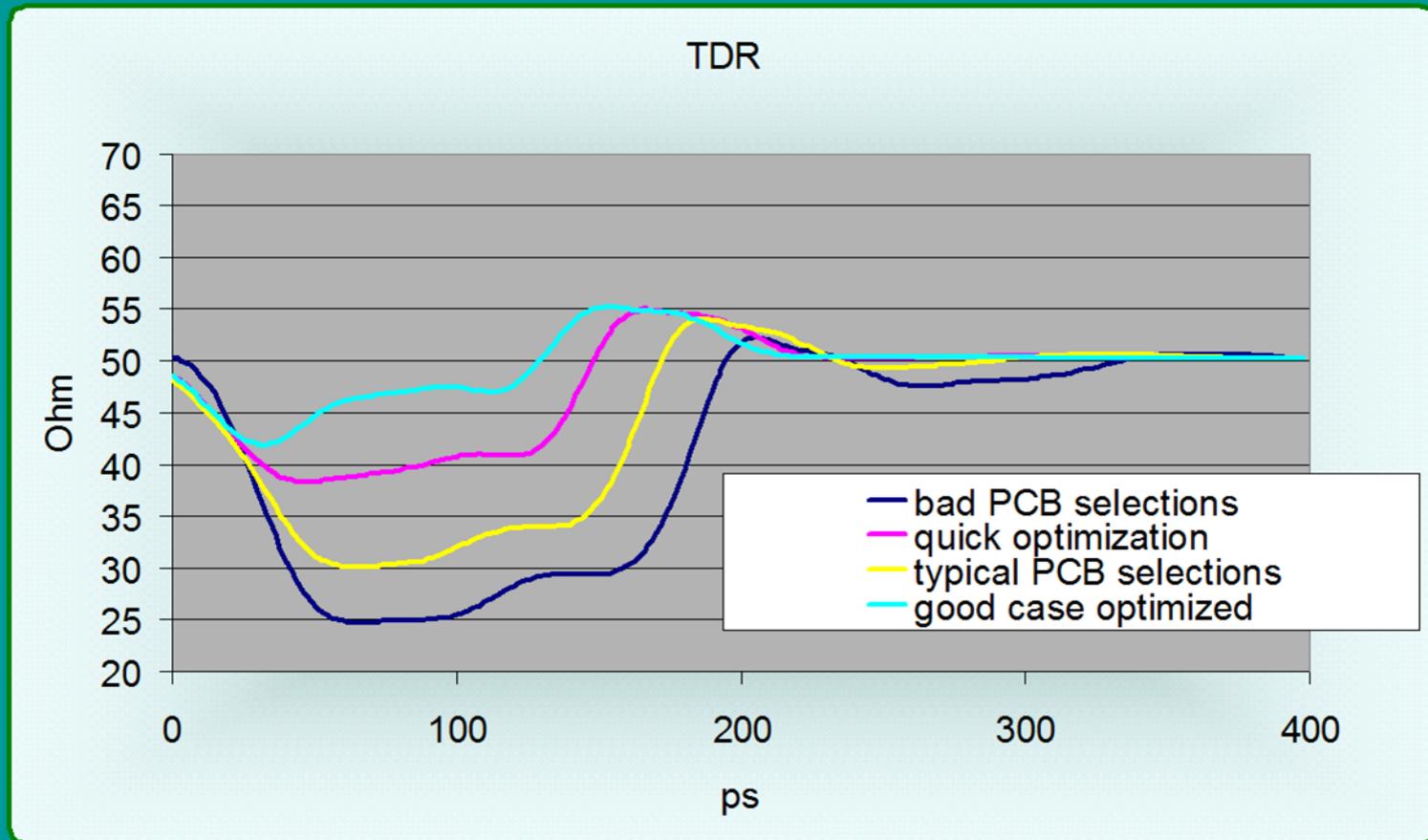
Return loss varies greatly depending on PCB parameter selections (pad and antipad sizes)

# Return loss S11



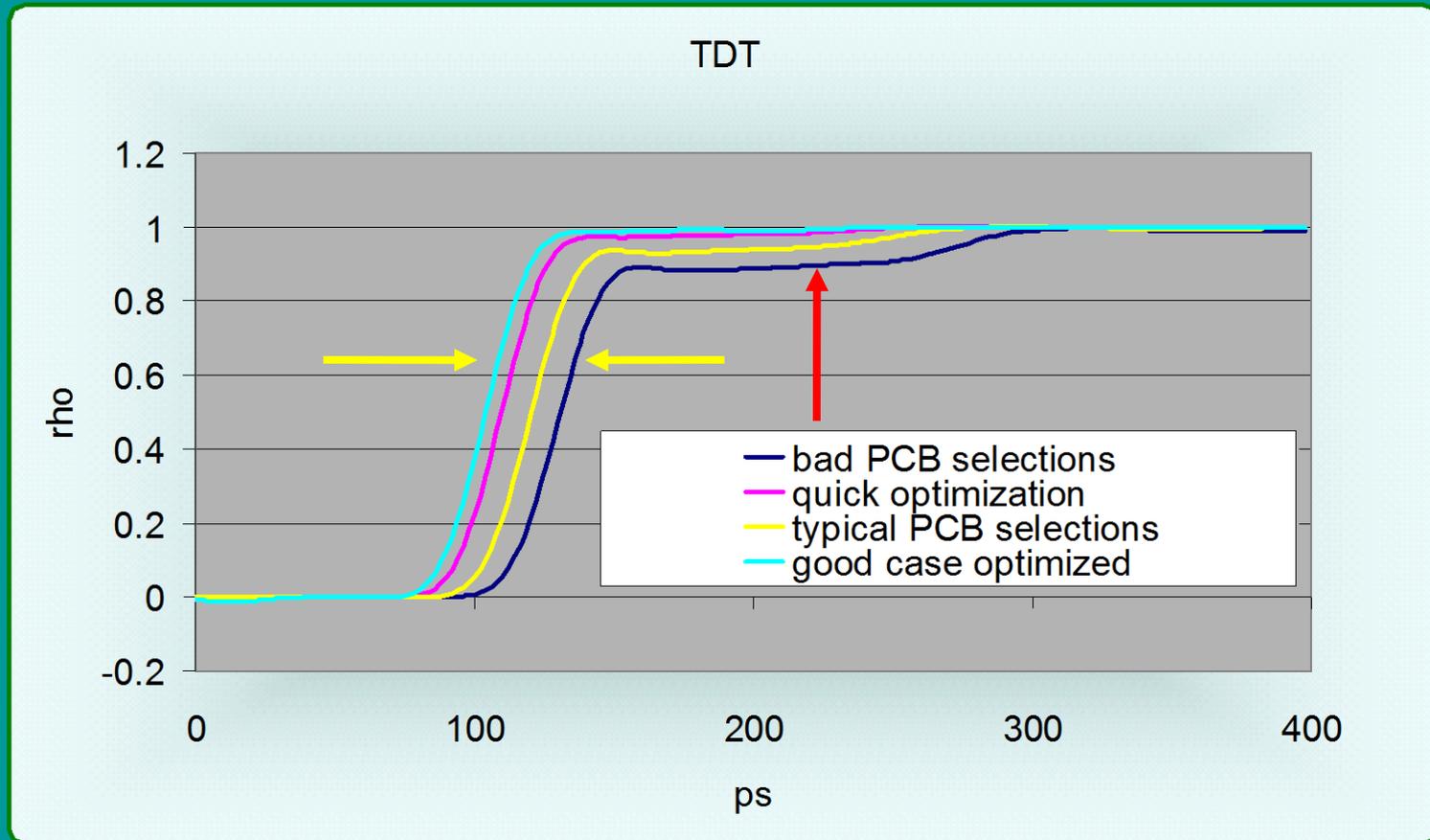
Substantial differences exist even at lower frequencies

# TDR



Impedance levels can vary greatly depending on parameter selection

# TDT



*Flat in rise can seriously degrade performance and perhaps even inhibit operation (red arrow)  
Timing differences can exist between paths of different levels of performance and optimization*

# Summary

- Optimization of the PCB design offers substantial performance improvements
- This is generally true for all configurations from stripline to micro-strip lines
- Material choices, pad and anti-pad sizes are examples of parameters available for optimization
- Improperly designed transitions into a PCB can eliminate any advantage of a high performance socket/connector
- Interface must be optimized together with a specific socket or connector